

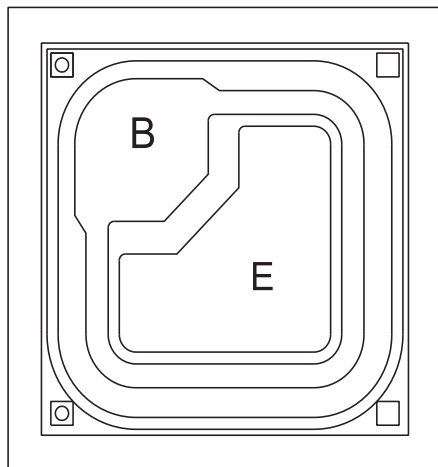
PROCESS CP588
Small Signal Transistor
PNP - Low Noise Amplifier Transistor Chip



PROCESS DETAILS

Process	EPITAXIAL PLANAR
Die Size	14.6 x 14.6 MILS
Die Thickness	9.0 MILS
Base Bonding Pad Area	3.9 x 3.9 MILS
Emitter Bonding Pad Area	5.5 x 5.5 MILS
Top Side Metalization	Al - 30,000Å
Back Side Metalization	Au - 18,000Å

GEOMETRY



BACKSIDE COLLECTOR R1

GROSS DIE PER 4 INCH WAFER

54,599

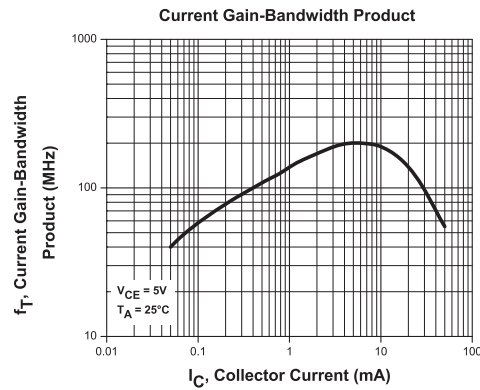
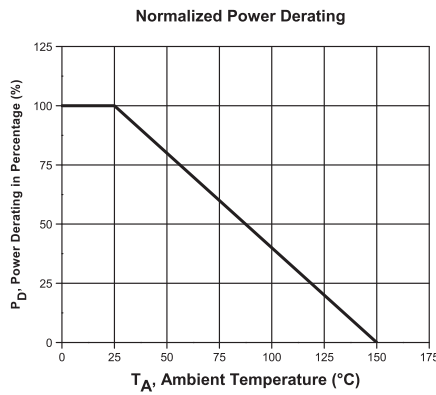
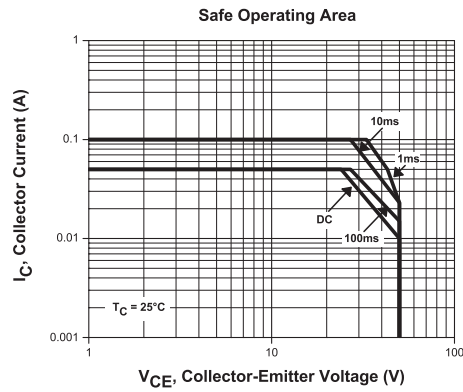
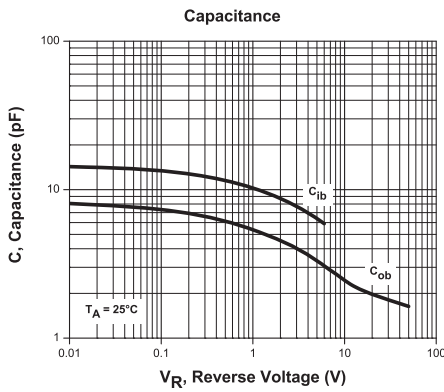
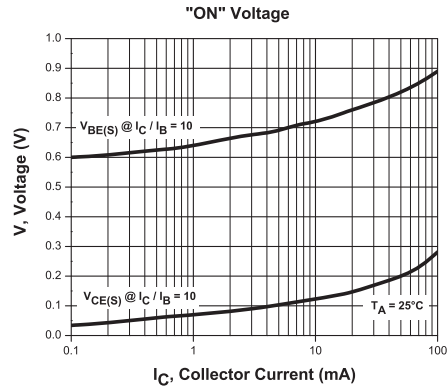
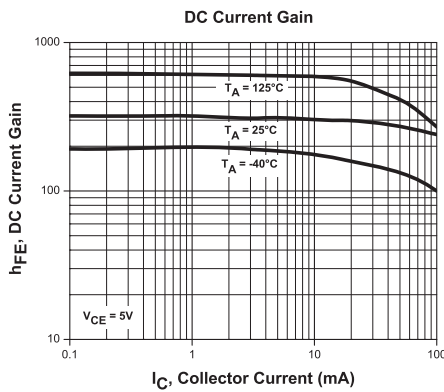
PRINCIPAL DEVICE TYPES

2N2605
2N3799
PN4250A
CMPT5086
CMPT5087

R4 (9-September 2011)

PROCESS CP588

Typical Electrical Characteristics



R4 (9-September 2011)

BARE DIE PACKING OPTIONS



BARE DIE IN TRAY (WAFFLE) PACK

CT: Singulated die in tray (waffle) pack.
(example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes).
(example: CP211-PART NUMBER-CM)



UNSAWN WAFER

WN: Full wafer, unsawn, 100% tested with reject die inked.
(example: CP211-PART NUMBER-WN)



SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring,
100% tested with reject die inked.
(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications:
www.centrasemi.com/bdspecs

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix " TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

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www.centrasemi.com

Worldwide Field Representatives:
www.centrasemi.com/wwreps

Worldwide Distributors:
www.centrasemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: www.centrasemi.com/terms



<http://www.centrasemi.com>

Product End of Life Notification

PDN ID:	PDN01147
Notification Date:	3/13/20
Last Buy Date:	9/13/20
Last Shipment Date	3/13/21

Summary: The CP188 and CP588 wafer processes are being discontinued and are now classified as End of Life (EOL). The replacement wafer processes are the CP388X and CP788X, respectively.

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

<u>Central Part Number</u>	<u>Replacement</u>
CP188-BC107A-CT	CP388X-BC107A-CT
CP188-BC108-CT	CP388X-BC108-CT
CP188-BC546B-CT	CP388X-BC546B-CT
CP188-BC546B-WR	CP388X-BC546B-WR
CP188-2N2919-CT	CP388X-2N2919-CT
CP188-2N5088-CT	CP388X-2N5088-CT
CP588-BCY70-WN	CP788X-BCY70-WN
CP588-BC556B-CT	CP788X-BC556B-CT
CP588-BC556B-WN	CP788X-BC556B-WN
CP588-BC556B-WR	CP788X-BC556B-WR
CP588-HBC556B-CM	CP788X-HBC556B-CM
CP588-2N2605-CT	CP788X-2N2605-CT
CP588-2N2605-WN	CP788X-2N2605-WN

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centrasemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.